

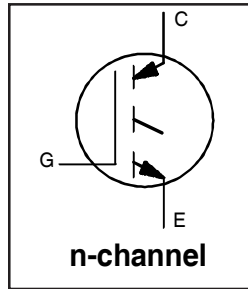
# IRG4BC30UPbF

INSULATED GATE BIPOLAR TRANSISTOR

UltraFast Speed IGBT

## Features

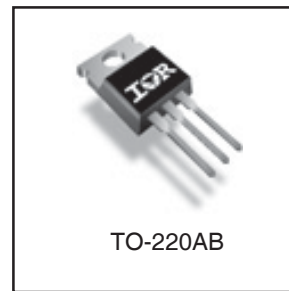
- UltraFast: optimized for high operating frequencies 8-40 kHz in hard switching, >200 kHz in resonant mode
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- Industry standard TO-220AB package
- Lead-Free



|                                   |
|-----------------------------------|
| $V_{CES} = 600V$                  |
| $V_{CE(on)} \text{ typ.} = 1.95V$ |
| @ $V_{GE} = 15V, I_C = 12A$       |

## Benefits

- Generation 4 IGBTs offer highest efficiency available
- IGBTs optimized for specified application conditions
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBTs



## Absolute Maximum Ratings

|                           | Parameter  | Max.               | Units |
|---------------------------|--|--------------------|-------|
| $V_{CES}$                 | Collector-to-Emitter Breakdown Voltage           | 600                | V     |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 23                 | A     |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 12                 |       |
| $I_{CM}$                  | Pulsed Collector Current ①                       | 92                 |       |
| $I_{LM}$                  | Clamped Inductive Load Current ②                 | 92                 |       |
| $V_{GE}$                  | Gate-to-Emitter Voltage                          | $\pm 20$           | V     |
| $E_{ARV}$                 | Reverse Voltage Avalanche Energy ③               | 10                 | mJ    |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 100                | W     |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 42                 |       |
| $T_J$                     | Operating Junction and Storage Temperature Range | -55 to + 150       | °C    |
| $T_{STG}$                 |  |                    |       |
|                           |  |                    |       |
|                           | Mounting torque, 6-32 or M3 screw.               | 10 lbf·in (1.1N·m) |       |

## Thermal Resistance

|                 | Parameter                                 | Typ.     | Max. | Units  |
|-----------------|---|----------|------|--------|
| $R_{\theta JC}$ | Junction-to-Case                          | ---      | 1.2  | °C/W   |
| $R_{\theta CS}$ | Case-to-Sink, Flat, Greased Surface       | 0.50     | ---  |        |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | ---      | 80   |        |
| Wt              | Weight                                    | 2 (0.07) | ---  | g (oz) |

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

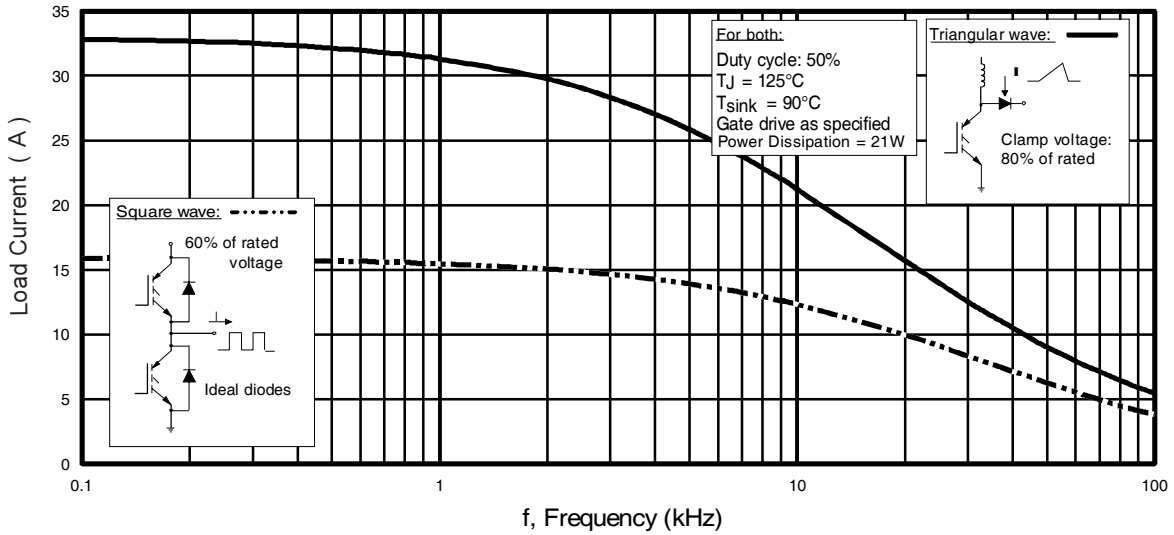
|                                 | Parameter                                | Min. | Typ. | Max.      | Units   | Conditions  |
|---------------------------------|--|------|------|-----------|---------|---|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage   | 600  | —    | —         | V       | $V_{GE} = 0V, I_C = 250\mu A$                         |
| $V_{(BR)ECS}$                   | Emitter-to-Collector Breakdown Voltage ④ | 18   | —    | —         | V       | $V_{GE} = 0V, I_C = 1.0A$                             |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage  | —    | 0.63 | —         | V/°C    | $V_{GE} = 0V, I_C = 1.0mA$                            |
| $V_{CE(ON)}$                    | Collector-to-Emitter Saturation Voltage  | —    | 1.95 | 2.1       | V       | $I_C = 12A, V_{GE} = 15V$                             |
|                                 |  | —    | 2.52 | —         |         | $I_C = 23A$   |
|                                 |  | —    | 2.09 | —         |         | $I_C = 12A, T_J = 150^\circ\text{C}$                  |
| $V_{GE(th)}$                    | Gate Threshold Voltage                   | 3.0  | —    | 6.0       |         | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage  | —    | -13  | —         | mV/°C   | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $g_{fe}$                        | Forward Transconductance ⑤               | 3.1  | 8.6  | —         | S       | $V_{CE} = 100V, I_C = 12A$                            |
| $I_{CES}$                       | Zero Gate Voltage Collector Current      | —    | —    | 250       | $\mu A$ | $V_{GE} = 0V, V_{CE} = 600V$                          |
|                                 |  | —    | —    | 2.0       |         | $V_{GE} = 0V, V_{CE} = 10V, T_J = 25^\circ\text{C}$   |
|                                 |  | —    | —    | 1000      |         | $V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current          | —    | —    | $\pm 100$ | nA      | $V_{GE} = \pm 20V$                                    |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

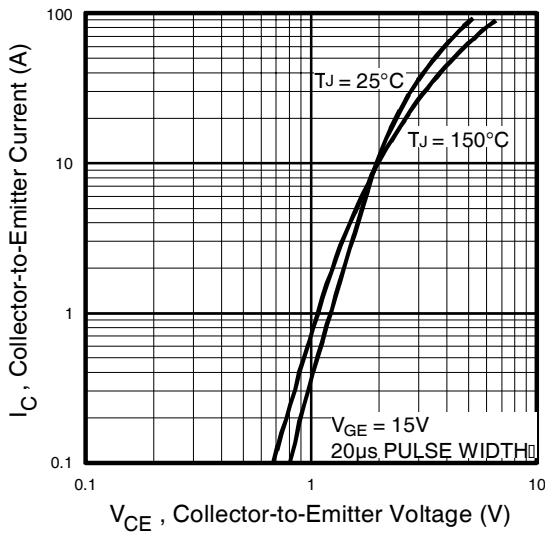
|              | Parameter                         | Min. | Typ. | Max. | Units | Conditions                     |
|--------------|-----------------------------------|------|------|------|-------|--------------------------------|
| $Q_g$        | Total Gate Charge (turn-on)       | —    | 50   | 75   | nC    | $I_C = 12A$                    |
| $Q_{ge}$     | Gate - Emitter Charge (turn-on)   | —    | 8.1  | 12   |       | $V_{CC} = 400V$                |
| $Q_{gc}$     | Gate - Collector Charge (turn-on) | —    | 18   | 27   |       | $V_{GE} = 15V$                 |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 17   | —    | ns    | $T_J = 25^\circ\text{C}$       |
| $t_r$        | Rise Time                         | —    | 9.6  | —    |       | $I_C = 12A, V_{CC} = 480V$     |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 78   | 120  |       | $V_{GE} = 15V, R_G = 23\Omega$ |
| $t_f$        | Fall Time                         | —    | 97   | 150  |       | Energy losses include "tail"   |
| $E_{on}$     | Turn-On Switching Loss            | —    | 0.16 | —    | mJ    | See Fig. 10, 11, 13, 14        |
| $E_{off}$    | Turn-Off Switching Loss           | —    | 0.20 | —    |       |                                |
| $E_{ts}$     | Total Switching Loss              | —    | 0.36 | 0.50 |       |                                |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 20   | —    | ns    | $T_J = 150^\circ\text{C}$ ,    |
| $t_r$        | Rise Time                         | —    | 13   | —    |       | $I_C = 12A, V_{CC} = 480V$     |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 180  | —    |       | $V_{GE} = 15V, R_G = 23\Omega$ |
| $t_f$        | Fall Time                         | —    | 140  | —    |       | Energy losses include "tail"   |
| $E_{ts}$     | Total Switching Loss              | —    | 0.73 | —    | mJ    | See Fig. 13, 14                |
| $L_E$        | Internal Source Inductance        | —    | 7.5  | —    | nH    | Measured 5mm from package      |
| $C_{ies}$    | Input Capacitance                 | —    | 1100 | —    | pF    | $V_{GE} = 0V$                  |
| $C_{oes}$    | Output Capacitance                | —    | 73   | —    |       | $V_{CC} = 30V$                 |
| $C_{res}$    | Reverse Transfer Capacitance      | —    | 14   | —    |       | $f = 1.0MHz$                   |

### Notes:

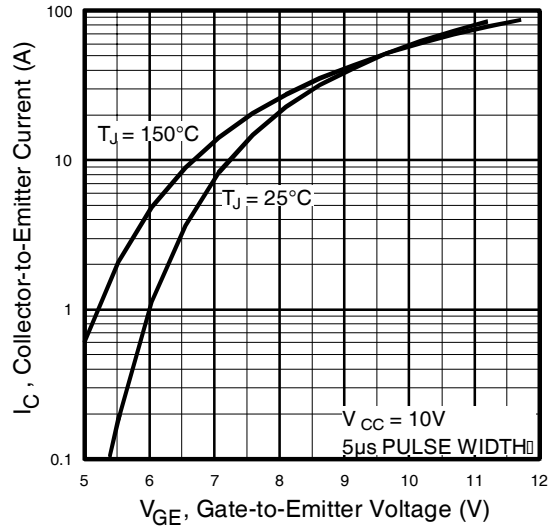
- ① Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature. ( See fig. 13b )
- ②  $V_{CC} = 80\%(V_{CES}), V_{GE} = 20V, L = 10\mu H, R_G = 23\Omega$ , (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ⑤ Pulse width  $5.0\mu s$ , single shot.



**Fig. 1 - Typical Load Current vs. Frequency**  
(For square wave,  $I = I_{RMS}$  of fundamental; for triangular wave,  $I = I_{PK}$ )



**Fig. 2 - Typical Output Characteristics**

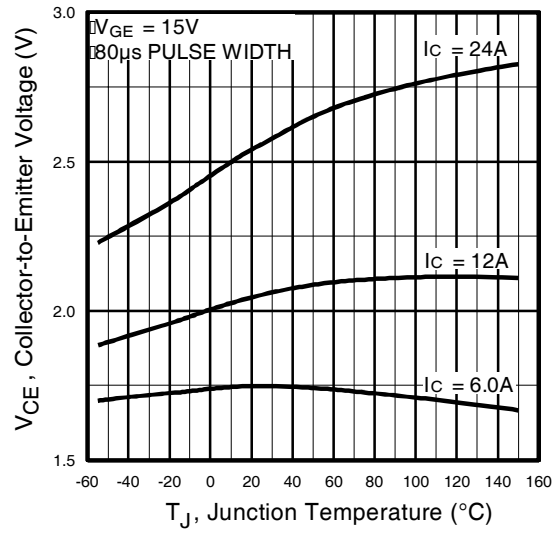


**Fig. 3 - Typical Transfer Characteristics**

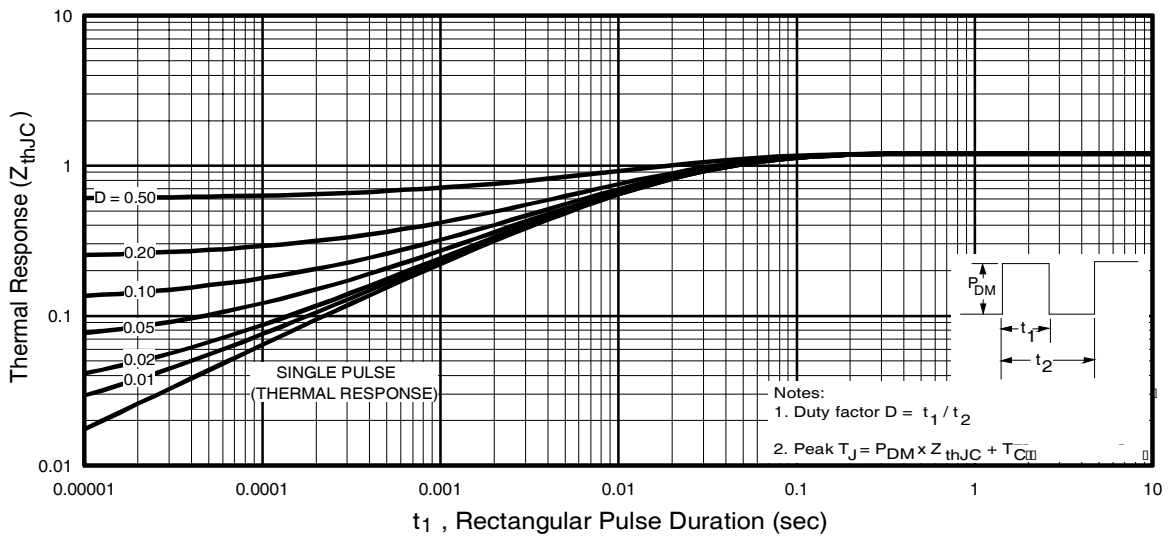
# IRG4BC30UPbF



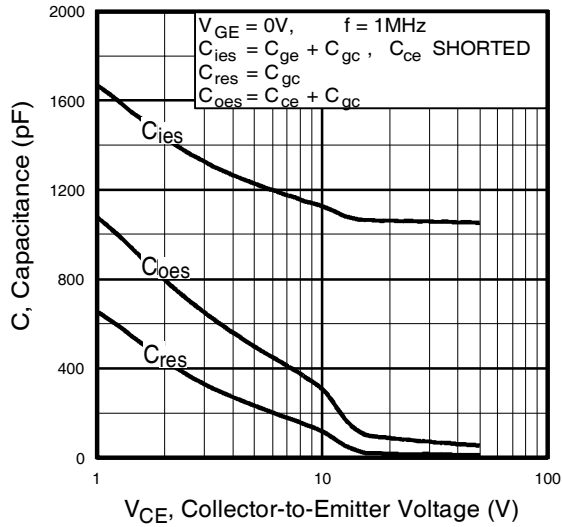
**Fig. 4 - Maximum Collector Current vs. Case Temperature**



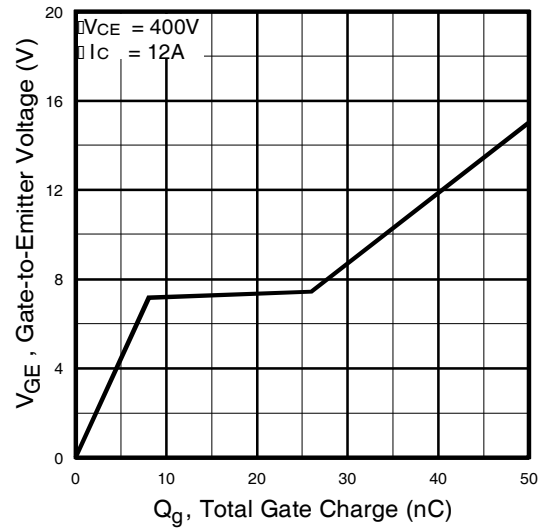
**Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature**



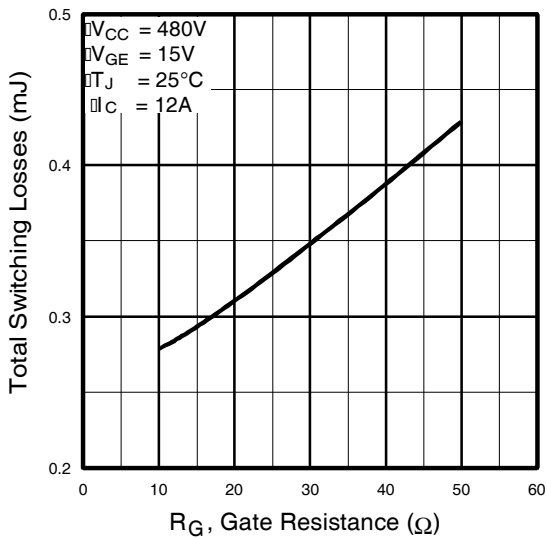
**Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**



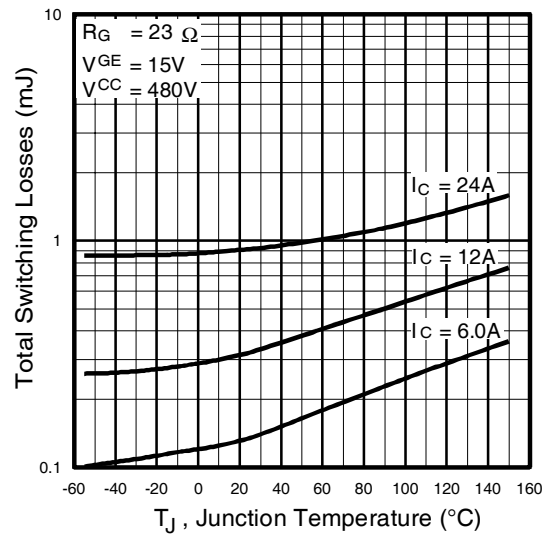
**Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage**

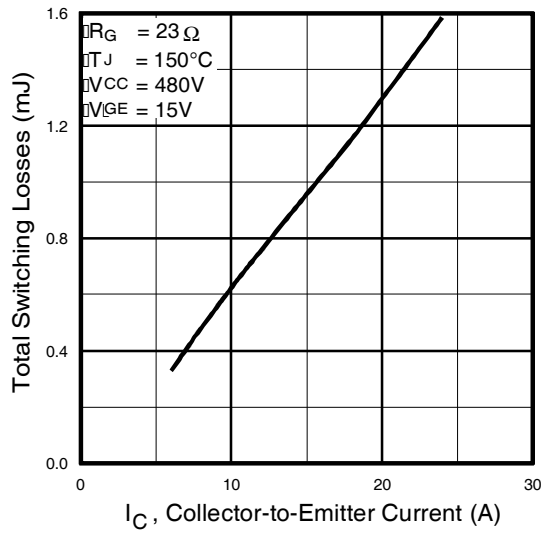


**Fig. 9 - Typical Switching Losses vs. Gate Resistance**

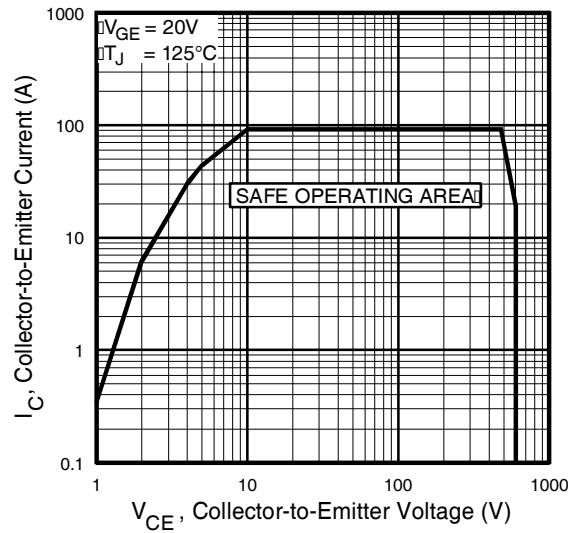


**Fig. 10 - Typical Switching Losses vs. Junction Temperature**

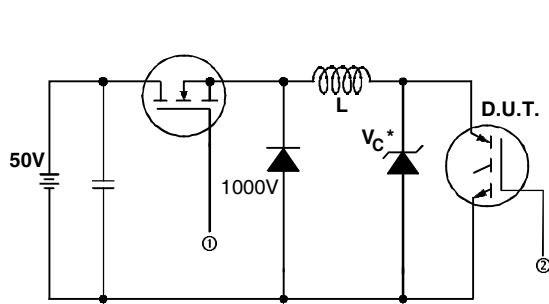
# IRG4BC30UPbF



**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current

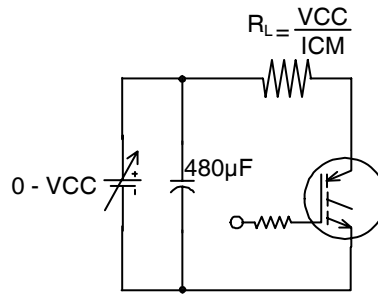


**Fig. 12** - Turn-Off SOA

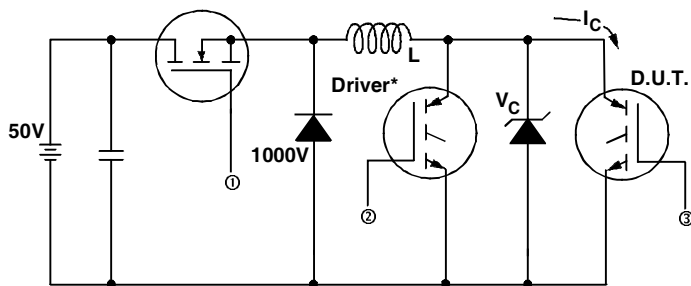


\* Driver same type as D.U.T.;  $V_c = 80\%$  of  $V_{ce(max)}$   
 \* Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated  $I_d$ .

**Fig. 13a** - Clamped Inductive Load Test Circuit



**Fig. 13b** - Pulsed Collector Current Test Circuit



**Fig. 14a** - Switching Loss Test Circuit

\* Driver same type as D.U.T.,  $V_C = 480V$

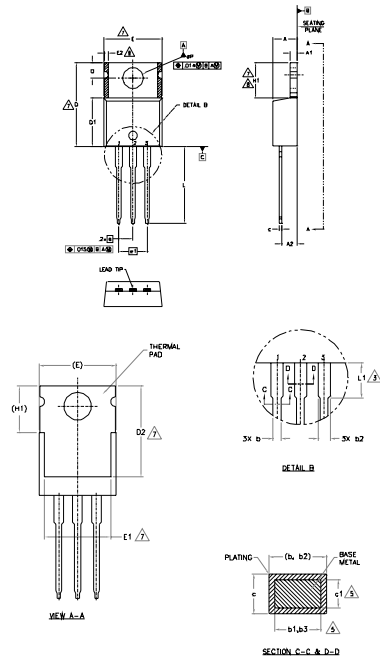


**Fig. 14b** - Switching Loss Waveforms

# IRG4BC30UPbF

International  
**IR** Rectifier

## TO-220AB Package Outline (Dimensions are shown in millimeters (inches))



- NOTES:
- 1.- DIMENSIONING AND TOLERANCING AS PER ASME Y14.5 M-1994.
  - 2.- DIMENSIONS ARE SHOWN IN INCHES (MILLIMETERS).
  - 3.- LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.
  - 4.- DIMENSION D, D1 & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
  - 5.- DIMENSION b1, b3 & c1 APPLY TO BASE METAL ONLY.
  - 6.- CONTROLLING DIMENSION - INCHES.
  - 7.- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E1, D2 & E1.
  - 8.- DIMENSION E2 x H1 DEFINE A ZONE WHERE STAMPING AND SOLDERATION IRREGULARITIES ARE ALLOWED.
  - 9.- OUTLINE CONFORMS TO JEDEC TO-220, EXCEPT A2 (max.) AND D2 (min.) WHERE DIMENSIONS ARE DERIVED FROM THE ACTUAL PACKAGE OUTLINE.

| SYMBOL | DIMENSIONS  |       |          |      | NOTES |
|--------|-------------|-------|----------|------|-------|
|        | MILLIMETERS |       | INCHES   |      |       |
|        | MIN.        | MAX.  | MIN.     | MAX. |       |
| A      | 3.56        | 4.83  | .140     | .190 |       |
| A1     | 0.51        | 1.40  | .020     | .055 |       |
| A2     | 2.03        | 2.92  | .080     | .115 |       |
| b      | 0.38        | 1.01  | .015     | .040 |       |
| b1     | 0.38        | 0.97  | .015     | .038 | 5     |
| b2     | 1.14        | 1.78  | .045     | .070 |       |
| b3     | 1.14        | 1.73  | .045     | .068 | 5     |
| c      | 0.36        | 0.61  | .014     | .024 |       |
| c1     | 0.36        | 0.56  | .014     | .022 | 5     |
| D      | 14.22       | 16.51 | .560     | .650 | 4     |
| D1     | 8.38        | 9.92  | .330     | .355 |       |
| D2     | 11.68       | 12.88 | .460     | .507 | 7     |
| E      | 9.65        | 10.67 | .380     | .420 | 4,7   |
| E1     | 6.86        | 8.89  | .270     | .350 | 7     |
| E2     | -           | 0.76  | -        | .030 | 8     |
| e      | .75 BSC     |       | .030 BSC |      |       |
| e1     | .60 BSC     |       | .020 BSC |      |       |
| H1     | 5.84        | 6.86  | .230     | .270 | 7,8   |
| L      | 12.70       | 14.73 | .500     | .580 |       |
| L1     | 3.56        | 4.06  | .140     | .160 |       |
| ØP     | 3.54        | 4.08  | .139     | .161 |       |
| O      | 2.54        | 3.42  | .100     | .135 |       |

**LEAD ASSIGNMENTS**

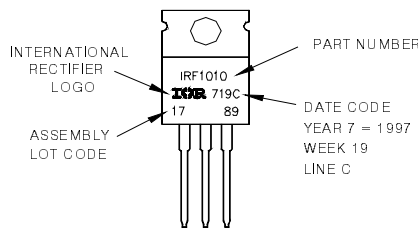
- 1- GATE
- 2- SNAIL
- 3- SOURCE

**DRIFT OFFSETS**

- 1- GATE
- 2- COLLECTOR
- 3- EMITTER

## TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010  
 LOT CODE 1789  
 ASSEMBLED ON WW 19, 1997  
 IN THE ASSEMBLY LINE 'C'  
**Note:** "P" in assembly line position indicates "Lead-Free"



**Note:** For the most current drawing please refer to IR website at <http://www.irf.com/package/>

Data and specifications subject to change without notice.

International  
**IR** Rectifier

**IR WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105  
 TAC Fax: (310) 252-7903  
 Visit us at [www.irf.com](http://www.irf.com) for sales contact information. 02/2010



## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [IGBT Transistors](#) category:*

*Click to view products by [Infineon](#) manufacturer:*

Other Similar products are found below :

[748152A](#) [APT20GT60BRDQ1G](#) [APT50GT60BRG](#) [NGTB10N60FG](#) [STGFW20V60DF](#) [APT30GP60BG](#) [APT45GR65B2DU30](#)  
[GT50JR22\(STA1ES\)](#) [TIG058E8-TL-H](#) [IGW40N120H3FKSA1](#) [VS-CPV364M4KPBF](#) [NGTB25N120FL2WAG](#) [NGTG40N120FL2WG](#)  
[RJH60F3DPQ-A0#T0](#) [APT40GR120B2SCD10](#) [APT15GT120BRG](#) [APT20GT60BRG](#) [NGTB75N65FL2WAG](#) [NGTG15N120FL2WG](#)  
[IXA30RG1200DHGLB](#) [IXA40RG1200DHGLB](#) [APT70GR65B2DU40](#) [NTE3320](#) [QP12W05S-37A](#) [IHF40N65R5SXXSA1](#) [APT70GR120J](#)  
[APT35GP120JDQ2](#) [XD15H120CX1](#) [XD25H120CX0](#) [XP15PJS120CL1B1](#) [IGW30N60H3FKSA1](#) [STGWA8M120DF3](#) [IGW08T120FKSA1](#)  
[IGW75N60H3FKSA1](#) [FGH60N60SMD\\_F085](#) [FGH75T65UPD](#) [STGWA15H120F2](#) [IKA10N60TXKSA1](#) [IHW20N120R5XKSA1](#)  
[RJH60D2DPP-M0#T2](#) [IKP20N60TXKSA1](#) [IHW20N65R5XKSA1](#) [APT70GR120JD60](#) [AOD5B60D](#) [APT70GR120L](#) [STGWT60H65FB](#)  
[STGWT60H65DFB](#) [STGWT40V60DF](#) [STGWT20V60DF](#) [STGB10NB37LZT4](#)